



12500 TI Boulevard, MS 8640, Dallas, Texas 75243

**Notification# 20230306003.1
Datasheet for THS309x
Change Notification**

Date: March 09, 2023
To: TOKYO ELECTRON DEVICE (DSTR) PCN

Dear Customer:

This is a notice of change to a product data sheet for a device that is currently offered by Texas Instruments. The details of this change are on the following pages.

We request you acknowledge receipt of this notification within **30** days of the date of this notice.

The proposed first ship date is indicated on page 3 of this notification, unless customer agreement has been reached on an earlier implementation of the change.

This notice does not change the end-of-life status of any product. Should product affected be on a previously issued product withdrawal/discontinuance notice, this notification does not extend the life of that product or change the life time buy offering/discontinuance plan.

For questions regarding this notice, contact your local Field Sales Representative or the PCN Team (PCN_ww_admin_team@list.ti.com).

Sincerely,

PCN Team
SC Business Services


Data Sheet Change Notification Attachments

Products Affected:

The devices listed on this page are a subset of the complete list of affected devices. According to our records, these are the devices that you have purchased within the past twenty-four (24) months. The corresponding customer part number is also listed, if available.

DEVICE	CUSTOMER PART NUMBER
THS3095DDA	null

Technical details of this Product Change follow on the next page(s).

PCN Number:	20230306003.1	PCN Date:	March 09, 2023																																												
Title:	Datasheet for THS309x																																														
Customer Contact:	PCN Manager	Dept:	Quality Services																																												
Proposed 1st Ship Date:	June 9, 2023																																														
Change Type:																																															
<input type="checkbox"/> Assembly Site	<input type="checkbox"/> Design	<input type="checkbox"/> Wafer Bump Site																																													
<input type="checkbox"/> Assembly Process	<input checked="" type="checkbox"/> Data Sheet	<input type="checkbox"/> Wafer Bump Material																																													
<input type="checkbox"/> Assembly Materials	<input type="checkbox"/> Part number change	<input type="checkbox"/> Wafer Bump Process																																													
<input type="checkbox"/> Mechanical Specification	<input type="checkbox"/> Test Site	<input type="checkbox"/> Wafer Fab Site																																													
<input type="checkbox"/> Packing/Shipping/Labeling	<input type="checkbox"/> Test Process	<input type="checkbox"/> Wafer Fab Materials																																													
		<input type="checkbox"/> Wafer Fab Process																																													
Notification Details																																															
Description of Change:																																															
<p>Texas Instruments Incorporated is announcing an information only notification. The product datasheet(s) is being updated as summarized below.</p>																																															
<div style="display: flex; justify-content: space-between; align-items: center;"> <div style="text-align: center;">  </div> <div style="text-align: right;"> THS3091, THS3095 <small>SLOS423J – SEPTEMBER 2003 – REVISED FEBRUARY 2023</small> </div> </div>																																															
<table border="0" style="width: 100%;"> <thead> <tr> <th style="text-align: left;">Changes from Revision I (December 2022) to Revision J (February 2023)</th> <th style="text-align: right;">Page</th> </tr> </thead> <tbody> <tr> <td>• Updated <i>Features</i> section.....</td> <td style="text-align: right;">1</td> </tr> <tr> <td>• Updated <i>Description</i> section.....</td> <td style="text-align: right;">1</td> </tr> <tr> <td>• Updated the <i>Device Comparison Table</i> section.....</td> <td style="text-align: right;">6</td> </tr> <tr> <td>• Removed D package information from the datasheet.....</td> <td style="text-align: right;">7</td> </tr> <tr> <td>• Removed continuous power dissipation specification from <i>Absolute Maximum Ratings</i> table</td> <td style="text-align: right;">8</td> </tr> <tr> <td>• Updated <i>ESD Ratings</i> table.....</td> <td style="text-align: right;">8</td> </tr> <tr> <td>• Updated <i>Thermal Information</i> table.....</td> <td style="text-align: right;">8</td> </tr> <tr> <td>• Changed <i>Electrical Characteristics THS3091</i> table to <i>Electrical Characteristics: V_S = ±15 V</i></td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed small-signal bandwidth at G = 1 from 235 MHz to 715 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed small-signal bandwidth at G = 2 from 210 MHz to 305 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed small-signal bandwidth at G = 5 from 190 MHz to 205 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed small-signal bandwidth at G = 10 from 180 MHz to 190 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Removed slew rate (25% to 75% level) specifications from <i>Electrical Characteristics: V_S = ±15 V</i> and <i>Electrical Characteristics: V_S = ±5 V</i> tables.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Added slew rate (10% to 90% level) specifications to <i>Electrical Characteristics: V_S = ±15 V</i> and <i>Electrical Characteristics: V_S = ±5 V</i> tables</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed rise and fall time from 5 ns to 2 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed settling time to 0.1% from 42 ns to 12.5 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed settling time to 0.01% from 72 ns to 18.5 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed second harmonic distortion at R_L = 100 Ω from 66 dBc to 72 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed second harmonic distortion at R_L = 1 kΩ from 77 dBc to 84 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed third harmonic distortion at R_L = 100 Ω from 74 dBc to 70 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> <tr> <td>• Changed third harmonic distortion at R_L = 1 kΩ from 69 dBc to 99 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....</td> <td style="text-align: right;">9</td> </tr> </tbody> </table>				Changes from Revision I (December 2022) to Revision J (February 2023)	Page	• Updated <i>Features</i> section.....	1	• Updated <i>Description</i> section.....	1	• Updated the <i>Device Comparison Table</i> section.....	6	• Removed D package information from the datasheet.....	7	• Removed continuous power dissipation specification from <i>Absolute Maximum Ratings</i> table	8	• Updated <i>ESD Ratings</i> table.....	8	• Updated <i>Thermal Information</i> table.....	8	• Changed <i>Electrical Characteristics THS3091</i> table to <i>Electrical Characteristics: V_S = ±15 V</i>	9	• Changed small-signal bandwidth at G = 1 from 235 MHz to 715 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed small-signal bandwidth at G = 2 from 210 MHz to 305 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed small-signal bandwidth at G = 5 from 190 MHz to 205 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed small-signal bandwidth at G = 10 from 180 MHz to 190 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Removed slew rate (25% to 75% level) specifications from <i>Electrical Characteristics: V_S = ±15 V</i> and <i>Electrical Characteristics: V_S = ±5 V</i> tables.....	9	• Added slew rate (10% to 90% level) specifications to <i>Electrical Characteristics: V_S = ±15 V</i> and <i>Electrical Characteristics: V_S = ±5 V</i> tables	9	• Changed rise and fall time from 5 ns to 2 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed settling time to 0.1% from 42 ns to 12.5 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed settling time to 0.01% from 72 ns to 18.5 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed second harmonic distortion at R _L = 100 Ω from 66 dBc to 72 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed second harmonic distortion at R _L = 1 kΩ from 77 dBc to 84 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed third harmonic distortion at R _L = 100 Ω from 74 dBc to 70 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9	• Changed third harmonic distortion at R _L = 1 kΩ from 69 dBc to 99 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9
Changes from Revision I (December 2022) to Revision J (February 2023)	Page																																														
• Updated <i>Features</i> section.....	1																																														
• Updated <i>Description</i> section.....	1																																														
• Updated the <i>Device Comparison Table</i> section.....	6																																														
• Removed D package information from the datasheet.....	7																																														
• Removed continuous power dissipation specification from <i>Absolute Maximum Ratings</i> table	8																																														
• Updated <i>ESD Ratings</i> table.....	8																																														
• Updated <i>Thermal Information</i> table.....	8																																														
• Changed <i>Electrical Characteristics THS3091</i> table to <i>Electrical Characteristics: V_S = ±15 V</i>	9																																														
• Changed small-signal bandwidth at G = 1 from 235 MHz to 715 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed small-signal bandwidth at G = 2 from 210 MHz to 305 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed small-signal bandwidth at G = 5 from 190 MHz to 205 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed small-signal bandwidth at G = 10 from 180 MHz to 190 MHz in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Removed slew rate (25% to 75% level) specifications from <i>Electrical Characteristics: V_S = ±15 V</i> and <i>Electrical Characteristics: V_S = ±5 V</i> tables.....	9																																														
• Added slew rate (10% to 90% level) specifications to <i>Electrical Characteristics: V_S = ±15 V</i> and <i>Electrical Characteristics: V_S = ±5 V</i> tables	9																																														
• Changed rise and fall time from 5 ns to 2 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed settling time to 0.1% from 42 ns to 12.5 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed settling time to 0.01% from 72 ns to 18.5 ns in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed second harmonic distortion at R _L = 100 Ω from 66 dBc to 72 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed second harmonic distortion at R _L = 1 kΩ from 77 dBc to 84 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed third harmonic distortion at R _L = 100 Ω from 74 dBc to 70 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														
• Changed third harmonic distortion at R _L = 1 kΩ from 69 dBc to 99 dBc in <i>Electrical Characteristics: V_S = ±15 V</i> table.....	9																																														

• Changed input voltage noise from 2 nV/√Hz to 1.1 nV/√Hz in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed noninverting input current noise from 14 pA/√Hz to 15 pA/√Hz in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Removed differential gain and differential phase specifications from <i>Electrical Characteristics: $V_S = \pm 15$ V</i> and <i>Electrical Characteristics: $V_S = \pm 5$ V</i> tables.....	9
• Changed inverting input current noise from 17 pA/√Hz to 14 pA/√Hz in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical transimpedance from 850 kΩ to 1800 kΩ in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Removed specifications with $T_A = 0^\circ\text{C}$ to 70°C test conditions in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> and <i>Electrical Characteristics: $V_S = \pm 5$ V</i> tables.....	9
• Changed maximum input offset voltage at $T_A = -40^\circ\text{C}$ to 85°C from 4 mV to 5 mV in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed maximum inverting input bias current at $T_A = -40^\circ\text{C}$ to 85°C from 20 μA to 25 μA in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed max input offset current at $T_A = 25^\circ\text{C}$ from 10 μA to 20 μA in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed max input offset current at $T_A = 0^\circ\text{C}$ to 85°C from 15 μA to 30 μA in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical average offset voltage drift from $\pm 10 \mu\text{V}/^\circ\text{C}$ to $\pm 19 \mu\text{V}/^\circ\text{C}$ in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical inverting bias current drift from $\pm 20 \text{ nA}/^\circ\text{C}$ to $\pm 80 \text{ nA}/^\circ\text{C}$ in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical average offset current drift from $\pm 20 \text{ nA}/^\circ\text{C}$ to $\pm 80 \text{ nA}/^\circ\text{C}$ in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical common-mode rejection ratio from 69 dB to 78 dB in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical noninverting input resistance from 1.3 MΩ to 0.7 MΩ in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical noninverting input capacitance from 0.1 pF to 2.4 pF in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical output current (sourcing) from 280 mA to 310 mA in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed typical output current (sinking) from 250 mA to 310 mA in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Removed specified operating voltage specifications from <i>Electrical Characteristics: $V_S = \pm 15$ V</i> and <i>Electrical Characteristics: $V_S = \pm 5$ V</i> tables.....	9
• Changed power supply rejection (+PSRR) from 75 dB to 85 dB in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	9
• Changed power supply rejection (-PSRR) from 73 dB to 82 dB in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table..	9
• Changed Electrical Characteristics THS3095 to <i>Electrical Characteristics: $V_S = \pm 5$ V</i>	11
• Changed small-signal bandwidth at $G = 1$ from 190 MHz to 485 MHz in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11
• Changed small-signal bandwidth at $G = 2$ from 180 MHz to 215 MHz in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11
• Changed small-signal bandwidth at $G = 10$ from 150 MHz to 160 MHz in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11
• Changed 0.1-dB bandwidth flatness from 65 MHz to 50 MHz in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table....	11
• Changed large signal bandwidth flatness from 160 MHz to 205 MHz in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11
• Changed rise and fall time from 5 ns to 2 ns in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11
• Changed settling time to 0.1% from 35 ns to 12.5 ns in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11
• Changed settling time to 0.01% from 73 ns to 26 ns in <i>Electrical Characteristics: $V_S = \pm 15$ V</i> table.....	11
• Changed second harmonic distortion at $R_L = 100 \Omega$ from 77 dBc to 74 dBc in <i>Electrical Characteristics: $V_S = \pm 5$ V</i> table.....	11

• Changed second harmonic distortion at $R_L = 1\text{ k}\Omega$ from 73 dBc to 76 dBc in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed third harmonic distortion at $R_L = 1\text{ k}\Omega$ from 68 dBc to 75 dBc in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed input voltage noise from 2 nV/ $\sqrt{\text{Hz}}$ to 1.1 nV/ $\sqrt{\text{Hz}}$ in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed noninverting input current noise from 14 pA/ $\sqrt{\text{Hz}}$ to 15 pA/ $\sqrt{\text{Hz}}$ in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed inverting input current noise from 17 pA/ $\sqrt{\text{Hz}}$ to 14 pA/ $\sqrt{\text{Hz}}$ in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical transimpedance from 700 k Ω to 1500 k Ω in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical input offset voltage from 0.3 mV to 0.6 mV in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed maximum input offset voltage at $T_A = -40^\circ\text{C}$ to 85°C from 3 mV to 3.5 mV in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed maximum inverting input bias current at $T_A = -40^\circ\text{C}$ to 85°C from 20 μA to 25 μA in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical input offset current at $T_A = 25^\circ\text{C}$ from 1 μA to 1.5 μA in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed max input offset current at $T_A = 0^\circ\text{C}$ to 85°C from 15 μA to 20 μA in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical average offset voltage drift from $\pm 10\text{ }\mu\text{V}/^\circ\text{C}$ to $\pm 20\text{ }\mu\text{V}/^\circ\text{C}$ in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical inverting bias current drift from $\pm 20\text{ nA}/^\circ\text{C}$ to $\pm 95\text{ nA}/^\circ\text{C}$ in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical average offset current drift from $\pm 20\text{ nA}/^\circ\text{C}$ to $\pm 90\text{ nA}/^\circ\text{C}$ in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical common-mode rejection ratio from 66 dB to 74 dB in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical noninverting input resistance from 1.1 M Ω to 0.45 M Ω in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical noninverting input capacitance from 0.1 pF to 2.6 pF in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical output current (sourcing) from 180 mA to 250 mA in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed typical output current (sinking) from -160 mA to -250 mA in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed power supply rejection (+PSRR) from 73 dB to 81 dB in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Changed power supply rejection (-PSRR) from 71 dB to 79 dB in <i>Electrical Characteristics: $V_S = \pm 5\text{ V}$ table</i>	11
• Removed <i>Dissipation Ratings</i> table.....	13
• Updated <i>Typical Characteristics ($\pm 15\text{ V}$)</i> section.....	13
• Updated <i>Typical Characteristics ($\pm 5\text{ V}$)</i> section.....	19
• Updated <i>Feature Description</i> section.....	21
• Updated <i>Device Functional Modes</i> section.....	22
• Updated <i>Application and Implementation</i> section.....	24
• Updated <i>Typical Application</i> section.....	24
• Updated <i>Layout</i> section.....	27

The datasheet number will be changing.

Device Family	Change From:	Change To:
THS309x	SLOS423I	SLOS423J

These changes may be reviewed at the datasheet links provided.

<http://www.ti.com/product/THS309x>

Reason for Change:			
To accurately reflect device characteristics.			
Anticipated impact on Fit, Form, Function, Quality or Reliability (positive / negative):			
Electrical specification performance changes as indicated above.			
Changes to product identification resulting from this PCN:			
None.			
Product Affected:			
THS3091D	THS3091DDA	THS3091DDAG3	THS3091DDAR
THS3091DDARG3	THS3091DR	THS3095D	THS3095DDA
THS3095DDAR			

For questions regarding this notice, e-mails can be sent to the contact shown below or your local Field Sales Representative.

Location	E-Mail
WW PCN Team	PCN_ww_admin_team@list.ti.com

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATASHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES "AS IS" AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, or other requirements. These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI's products are provided subject to TI's Terms of Sale (www.ti.com/legal/termsofsale.html) or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI's provision of these resources does not expand or otherwise alter TI's applicable warranties or warranty disclaimers for TI products.